

IFW



MEG03-005CCC

USPTO
RECEIPTS ACCOUNTING
DIVISION

2008 SEP 24 PM 5:09

September 19, 2008

TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: Saile Ackerman LLC
Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, NY 12603

RECEIVED

SEP 30 2008

OFFICE OF PETITIONS

SUBJECT: Serial #: 10/796427
File Date: March 9, 2004
Inventor: Lin, M.S.
Examiner: M. Lewis
Art Unit: 2822
Title: Wirebond Pad For Semiconductor Chip Or Wafer

A Request for Continued Examination for the above-mentioned application was filed on July 29, 2008, but with a small entity fee amount. The fee amount paid for the RCE was \$405. Therefore, a total deficiency payment of \$405 is owed and herein enclosed.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on September 19, 2008.

Signature 
Stephen B. Ackerman, Reg. No. 37,761

Date: September 19, 2008

09/25/2008 DALLEN 00000020 190033 10796427

01 FC:1461 405.00 DA

The Commissioner is hereby authorized to charge the additional fee of \$405 to
Deposit Account No. 19-0033.

USPTO
DIVISION

2008 SEP 24 PM 5:09

It is requested that should there be any problems, please call the undersigned
Attorney at (845) 452-5863.

Respectfully submitted,



Stephen B. Ackerman, Reg. No. 37,761

RECEIVED
SEP 30 2008
OFFICE OF PETITIONS